54F64,74F64

54F64 74F64 4-2-3-2-Input AND/OR Invert Gate



Literature Number: SNOS209A



54F/74F64 4-2-3-2-Input AND-OR-Invert Gate

General Description

This device contains gates configured to perform a 4-2-3-2 input AND-OR-INVERT function.

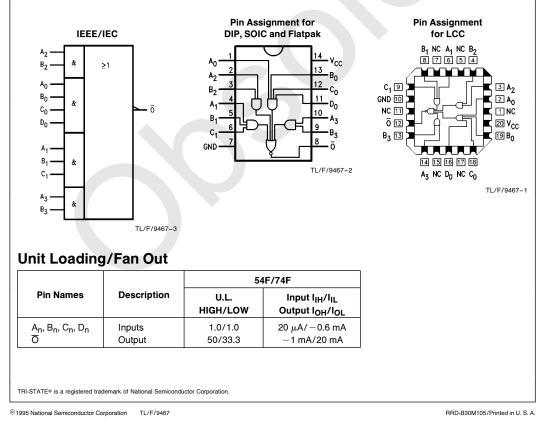
Commercial	Military	Package Number	Package Description		
74F64PC		N14A	14-Lead (0.300" Wide) Molded Dual-In-Line		
	54F64DM (Note 2)	J14A	14-Lead Ceramic Dual-In-Line		
74F64SC (Note 1)		M14A	14-Lead (0.150" Wide) Molded Small Outline, JEDEC		
	54F64FM (Note 2)	W14B	14-Lead Cerpack		
	54F64LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C		

Note 1: Devices also available in 13" reel. Use suffix = SCX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

Logic Symbol

Connection Diagrams



54F/74F64 4-2-3-2-Input AND-OR-Invert Gate

November 1994

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +175°C
Plastic	-55°C to +150°C
V _{CC} Pin Potential to	
Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to $+7.0V$
Input Current (Note 2)	-30 mA to $+5.0$ mA
Voltage Applied to Output	
in HIGH State (with $V_{CC} = 0V$)	
Standard Output	-0.5V to V _{CC}
TRI-STATE [®] Output	-0.5V to $+5.5V$
Current Applied to Output	
in LOW State (Max)	twice the rated IOI (mA)

Recommended Operating Conditions

Free Air Ambient Temperature

Military	-55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+ 4.5V to + 5.5V

in LOW State (Max) twice the rated I_{OL} (mA) Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

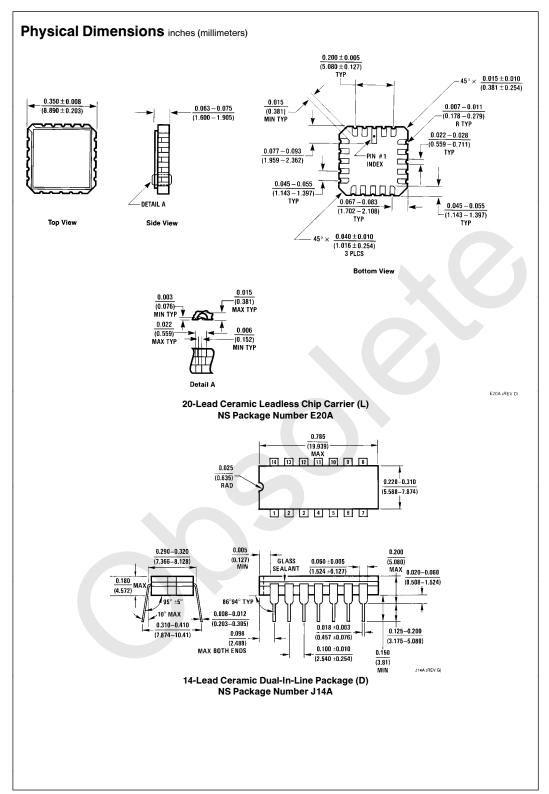
DC Electrical Characteristics

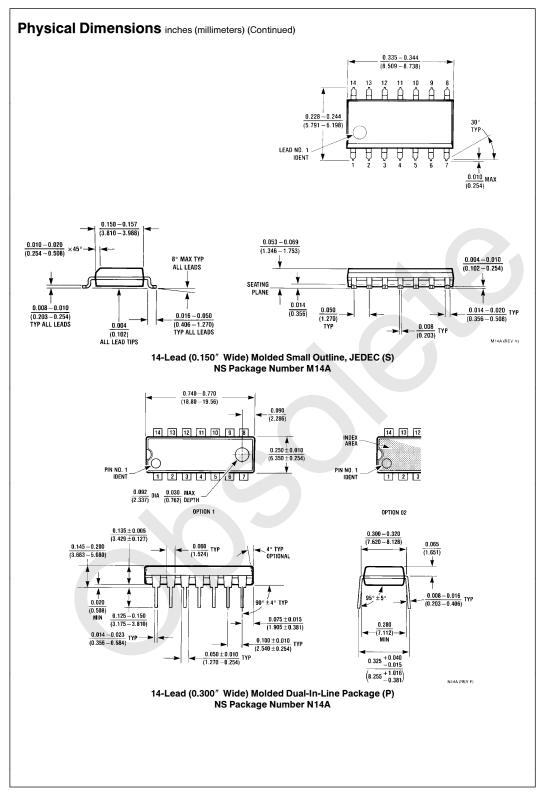
Symbol	Parameter		54F/74F			Units	Vcc	Conditions
oyinibol			Min	Тур	Мах	onito	•00	Conditions
V _{IH}	Input HIGH Voltage		2.0			>		Recognized as a HIGH Sign
V _{IL}	Input LOW Voltage				0.8	>		Recognized as a LOW Sign
V _{CD}	Input Clamp Diode Vo	oltage			-1.2	v	Min	$I_{IN} = -18 \text{ mA}$
V _{OH}	Output HIGH Voltage	54F 10% V _{CC} 74F 10% V _{CC} 74F 5% V _{CC}	2.5 2.5 2.7			v	Min	$I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$
V _{OL}	Output LOW Voltage	54F 10% V _{CC} 74F 10% V _{CC}			0.5 0.5	v	Min	$I_{OL} = 20 \text{ mA}$ $I_{OL} = 20 \text{ mA}$
IIH	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	$V_{IN} = 2.7V$
I _{BVI}	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	$V_{IN} = 7.0V$
ICEX	Output High Leakage Current	54F 74F			250 50	μΑ	Max	$V_{OUT} = V_{CC}$
V _{ID}	Input Leakage Test	74F	4.75			V	0.0	$I_{ID} = 1.9 \mu A$ All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	V _{IOD} = 150 mV All Other Pins Grounded
IIL	Input LOW Current				-0.6	mA	Max	$V_{IN} = 0.5V$
I _{OS}	Output Short-Circuit C	Current	-60		-150	mA	Max	$V_{OUT} = 0V$
ICCH	Power Supply Current	:		1.9	2.8	mA	Max	V _O = HIGH
ICCL	Power Supply Current	t		3.1	4.7	mA	Max	$V_{O} = LOW$

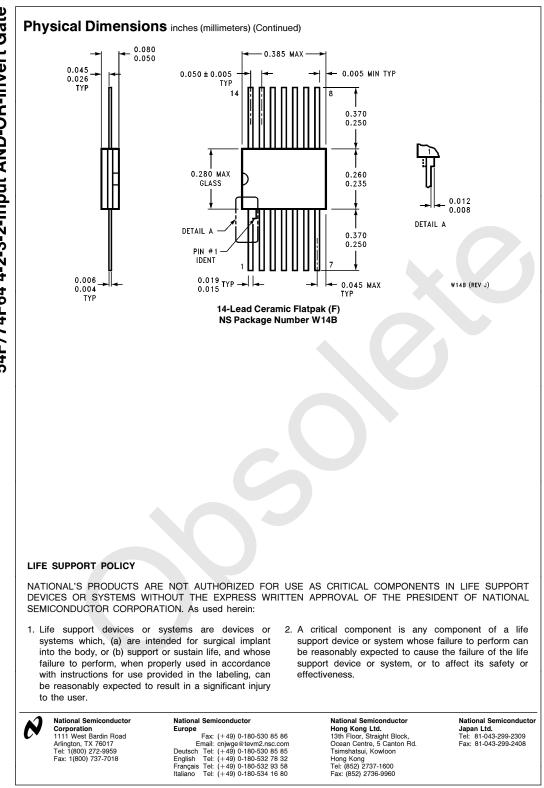
AC Electrical Characteristics									
		$74F \\ T_{A} = +25^{\circ}C \\ V_{CC} = +5.0V \\ C_{L} = 50 \text{ pF}$			54F T _A , V _{CC} = Mil C _L = 50 pF		74F T _A , V _{CC} = Com C _L = 50 pF		Units
Symbol	Parameter								
		Min	Тур	Мах	Min	Мах	Min	Max	
t _{PLH}	Propagation Delay	2.5	4.6	6.5	2.5	8.5	2.5	7.5	
t _{PHL}	A_n , B_n , C_n , D_n to \overline{O}	1.5	3.2	4.5	1.5	6.5	1.5	5.5	ns

Ordering Information The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:

74F 64 S 74F 64 S	C X Special Variations QB = Military grade device with environmental and burn-in processing X = Devices shipped in 13" reel
Package Code P = Plastic DIP D = Ceramic DIP F = Flatpak L = Leadless Chip Carrier (LCC) S = Small Outline SOIC	Temperature Range C = Commercial (0°C to +70°C) M = Military (-55°C to +125°C)







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